



SMT GaAs PHEMT MMIC LOW NOISE AMPLIFIER, 21 - 29 GHz

Typical Applications

The HMC341LC3B is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios & VSAT
- Test Equipment & Sensors
- Military End-Use

Features

2.5 dB Noise Figure

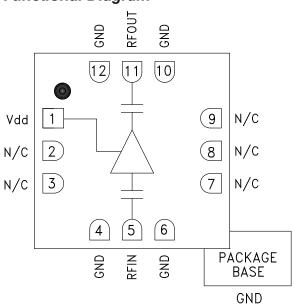
13 dB Gain

+3V @ 35 mA Supply

50 Ohm Matched Input/Output

RoHS Compliant 3x3 mm SMT Package

Functional Diagram



General Description

The HMC341LC3B is a GaAs pHEMT MMIC Low Noise Amplifier housed in a leadless RoHS compliant SMT package. Operating from 21 to 29 GHz, the amplifier provides 13 dB of gain and a noise figure of 2.5 dB from a single +3V supply. The RF I/Os are DC blocked and matched to 50 Ohms requiring no external components. The HMC341LC3B eliminates the need for wire bonding, allowing the use of surface mount manufacturing techniques.

Electrical Specifications, $T_A = +25^{\circ}$ C, Vdd = +3V, Idd = 35 mA

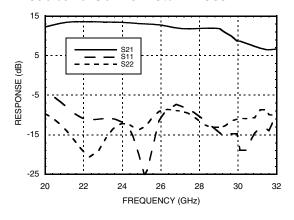
Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range	21 - 24		24 - 26		26 - 29		GHz			
Gain	10.5	13.5		10	13		9	12		dB
Gain Variation Over Temperature		0.016	0.025		0.016	0.025		0.016	0.025	dB/ °C
Noise Figure		3.25	5		3	3.5		2.5	3	dB
Input Return Loss		10			11			9		dB
Output Return Loss		14			10			9		dB
Output Power for 1 dB Compression (P1dB)		8			8.5			8.5		dBm
Saturated Output Power (Psat)		11			11.5			11.5		dBm
Output Third Order Intercept (IP3)		19			19			19		dBm
Supply Current (Idd) (Vdd = +3V)		35			35			35		mA



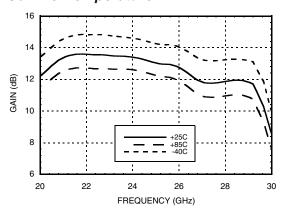


SMT GaAs PHEMT MMIC LOW NOISE AMPLIFIER, 21 - 29 GHz

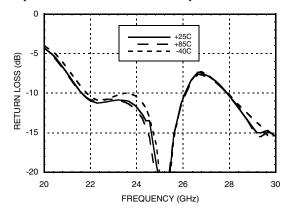
Broadband Gain & Return Loss



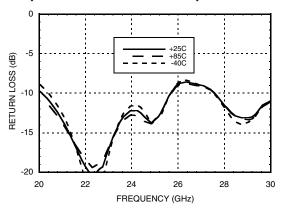
Gain vs. Temperature



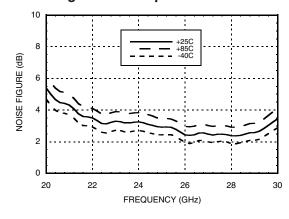
Input Return Loss vs. Temperature



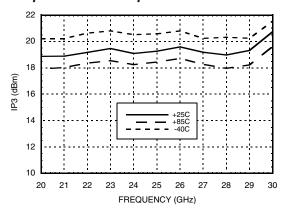
Output Return Loss vs. Temperature



Noise Figure vs. Temperature



Output IP3 vs. Temperature

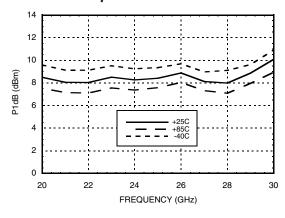




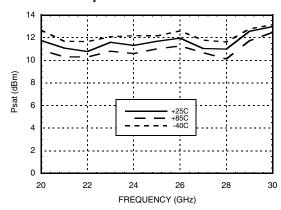


SMT GaAs PHEMT MMIC LOW NOISE AMPLIFIER, 21 - 29 GHz

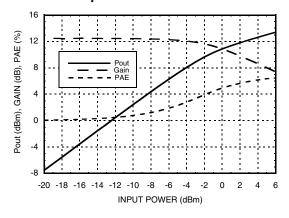
P1dB vs. Temperature



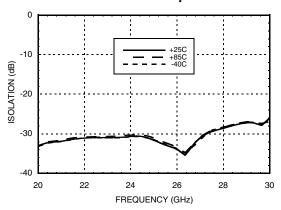
Psat vs. Temperature



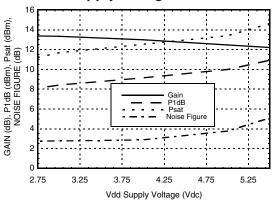
Power Compression @ 25 GHz



Reverse Isolation vs. Temperature



Gain, Power & Noise Figure vs. Supply Voltage @ 25 GHz







SMT GaAs PHEMT MMIC LOW NOISE AMPLIFIER, 21 - 29 GHz

Absolute Maximum Ratings

Drain Bias Voltage (Vdd)	+5.5 Vdc
RF Input Power (RFIN)(Vdd = +3.0 Vdc)	+5 dBm
Channel Temperature	175 °C
Continuous Pdiss (T= 85 °C) (derate 5.43 mW/°C above 85 °C)	0.489 W
Thermal Resistance (channel to ground paddle)	184 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

Typical Supply Current vs. Vdd

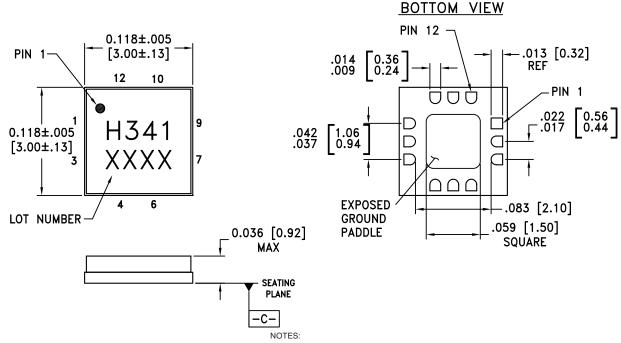
Vdd (Vdc)	ldd (mA)
+2.7	34
+3.0	35
+4.0	38
+5.0	41

Note: Amplifier will operate over full voltage ranges shown above.



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing



- 1. PACKAGE BODY MATERIAL: ALUMINA.
- 2. LEAD AND GROUND PADDLE PLATING: GOLD FLASH OVER NICKEL.
- 3. DIMENSIONS ARE IN INCHES (MILLIMETERS).
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05MM DATUM $\overline{-\,C\,-}$
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [2]
HMC341LC3B	Alumina, White	Gold over Nickel	MSL3 [1]	H341 XXXX

^[1] Max peak reflow temperature of 260 °C

^{[2] 4-}Digit lot number XXXX





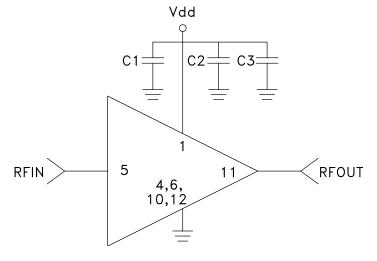
SMT GaAs PHEMT MMIC LOW NOISE AMPLIFIER, 21 - 29 GHz

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	Vdd	Power Supply Voltage for the amplifier. External bypass capacitors of 100 pF, 1000pF, and 2.2 µF are required.	oVdd
2, 3, 7-9	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance.	
4, 6, 10, 12	GND	Package bottom has an exposed metal paddle that must also be connected to RF/DC ground.	GND
5	RFIN	This pin is AC coupled and matched to 50 Ohms from 21 - 29 GHz.	RFIN O——
11	RFOUT	This pin is AC coupled and matched to 50 Ohms from 21 - 29 GHz.	— —○ RFOUT

Application Circuit

Component	Value
C1	100 pF
C2	1,000 pF
C3	2.2 µF

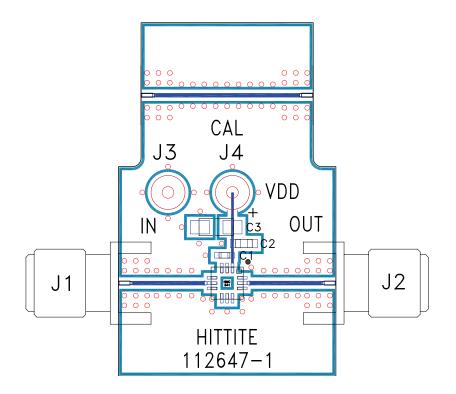






SMT GaAs PHEMT MMIC LOW NOISE AMPLIFIER, 21 - 29 GHz

Evaluation PCB



List of Materials for Evaluation PCB 112646 [1]

Item	Description
J1, J2	SRI K-connector
J3, J4	DC Pin
C1	100 pF capacitor, 0402 Pkg
C2	1,000 pF Capacitor, 0603 Pkg
C3	2.2µF Capacitor, Tantalum
U1	HMC341LC3B Amplifier
PCB [2]	112647 Evaluation PCB

^[1] Reference this number when ordering complete evaluation PCB

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

^[2] Circuit Board Material: Rogers 4350.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Development Tools category:

Click to view products by Analog Devices manufacturer:

Other Similar products are found below:

MAAM-011117 MAAP-015036-DIEEV2 EV1HMC1113LP5 EV1HMC6146BLC5A EV1HMC637ALP5 EVAL-ADG919EBZ ADL5363EVALZ LMV228SDEVAL SKYA21001-EVB SMP1331-085-EVB EV1HMC618ALP3 EVAL01-HMC1041LC4 MAAL-011111-000SMB
MAAM-009633-001SMB 107712-HMC369LP3 107780-HMC322ALP4 SP000416870 EV1HMC470ALP3 EV1HMC520ALC4
EV1HMC244AG16 124694-HMC742ALP5 SC20ASATEA-8GB-STD MAX2837EVKIT+ MAX2612EVKIT# MAX2692EVKIT#
SKY12343-364LF-EVB 108703-HMC452QS16G EV1HMC863ALC4 EV1HMC427ALP3E 119197-HMC658LP2 EV1HMC647ALP6
ADL5725-EVALZ 106815-HMC441LM1 EV1HMC1018ALP4 UXN14M9PE MAX2016EVKIT EV1HMC939ALP4 MAX2410EVKIT
MAX2204EVKIT+ EV1HMC8073LP3D SIMSA868-DKL SIMSA868C-DKL SKY65806-636EK1 SKY68020-11EK1 SKY67159-396EK1
SKY66181-11-EK1 SKY65804-696EK1 SKY13396-397LF-EVB SKY13380-350LF-EVB SKY13373-460LF-EVB